PLUS Search Results for S/N 09/451,619, Searched September 12, 2001 (Top 50)

4577215	4618876	4802137	5605853	5940705
5482879	4903097	5212541	5612237	5946240
5879992	5526307	5216268	5625213	5950087
6229176	5760435	5216269	5702965	5972753
5016068	6069381	5289026	5801993	6034892
5295107	6207989	5292681	5814543	6037226
6046086	6239465	5432109	5851880	6093607
4442447	4417264	5447877	5852312	6124168
4513397	4558339	5457061	5858840	6180977
4592130	4590665	5595920	5877525	6188102

## Most Frequently Occurring Classifications of Patents Returned From A Search of 09/451,619 on September 12, 2001

## **Combined Classifications**

- 12 257/315
- 12 257/316
- 10 438/264
- 9 257/321
- 9 438/266
- 7 257/314
- 6 365/185.18
- 5 257/317
- 5 365/185.14
- 5 438/258
- 4 257/319
- 4 365/185.29
- 4 365/185.33
- 4 438/257
- 4 438/265
- 3 257/320
- 3 365/185.01
- 3 365/185.06
- 3 365/185.1
- 3 365/185.16
- 3 365/185.27
- 3 365/185.28
- 3 438/201
- 3 438/267
- 2 257/318
- 2 257/324
- 2 257/330
- 2 365/185.3
- 2 365/185.31
- 2 438/211
- 2 438/261
- 2 438/263
- 2 438/286
- 2 438/297
- 2 438/588
- 2 438/593
- 2 438/594

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(2 OR, 10 XR)
12 257/315
    Class 257: ACTIVE SOLID-STATE DEVICES
                    FIELD EFFECT DEVICE
    257/213
                     .Having insulated electrode (e.g., MOSFET, MOS
    257/288
               diode)
                     .. Variable threshold (e.g., floating gate
    257/314
              memory device)
                     ...With floating gate electrode
    257/315
              (3 OR, 9 XR)
12 257/316
    Class 257: ACTIVE SOLID-STATE DEVICES
    257/213
                     FIELD EFFECT DEVICE
    257/288
                     .Having insulated electrode (e.g., MOSFET, MOS
                diode)
                     .. Variable threshold (e.g., floating gate
    257/314
               memory device)
                     ...With floating gate electrode
    257/315
                     ....With additional contacted control electrode
    257/316
              (6 OR, 4 XR)
10 438/264
    Class 438: SEMICONDUCTOR DEVICE MANUFACTURING: PROCESS
                     MAKING FIELD EFFECT DEVICE HAVING PAIR OF
    438/142
                ACTIVE REGIONS SEPARATED BY GATE STRUCTURE BY FORMATION OR
                ALTERATION OF SEMICONDUCTIVE ACTIVE REGIONS
                     .Having insulated gate (e.g., IGFET, MISFET,
    438/197
               MOSFET, etc.)
     438/257
                     ...Having additional gate electrode surrounded
               by dielectric (i.e., floating gate)
                     ...Tunneling insulator
     438/264
              (4 OR, 5 XR)
9 257/321
     Class 257: ACTIVE SOLID-STATE DEVICES
                     FIELD EFFECT DEVICE
     257/213
                     .Having insulated electrode (e.g., MOSFET, MOS
     257/288
                diode)
                     .. Variable threshold (e.g., floating gate
     257/314
                memory device)
                     ...With floating gate electrode
     257/315
                     ....With additional contacted control electrode
     257/316
                     .....With thin insulator region for charging or
     257/321
              discharging floating electrode by quantum mechanical
              tunneling
9 438/266
              (2 OR, 7 XR)
     Class 438: SEMICONDUCTOR DEVICE MANUFACTURING: PROCESS
                     MAKING FIELD EFFECT DEVICE HAVING PAIR OF
     438/142
                ACTIVE REGIONS SEPARATED BY GATE STRUCTURE BY FORMATION OR
                ALTERATION OF SEMICONDUCTIVE ACTIVE REGIONS
                     .Having insulated gate (e.g., IGFET, MISFET,
     438/197
                MOSFET, etc.)
                     .. Having additional gate electrode surrounded
     438/257
               by dielectric (i.e., floating gate)
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... Having additional, nonmemory control 438/266 electrode or channel portion (e.g., for accessing field effect transistor structure, etc.) 7 257/314 (3 OR, 4 XR) Class 257: ACTIVE SOLID-STATE DEVICES 257/213 FIELD EFFECT DEVICE 257/288 .Having insulated electrode (e.g., MOSFET, MOS diode) 257/314 .. Variable threshold (e.g., floating gate memory device) 6 365/185.18 (0 OR, 6 XR) Class 365: STATIC INFORMATION STORAGE AND RETRIEVAL 365/185.01 FLOATING GATE 365/185.18 .Particular biasing 5 257/317 (1 OR, 4 XR) Class 257: ACTIVE SOLID-STATE DEVICES FIELD EFFECT DEVICE 257/213 257/288 .Having insulated electrode (e.g., MOSFET, MOS diode) .. Variable threshold (e.g., floating gate 257/314 memory device) ...With floating gate electrode 257/315 ....With additional contacted control electrode 257/316 .....With irregularities on electrode to 257/317 facilitate charging or discharging of floating electrode 5 365/185.14 (2 OR, 3 XR) Class 365: STATIC INFORMATION STORAGE AND RETRIEVAL FLOATING GATE 365/185.01 .Particular connection 365/185.05 365/185.14 .. Program gate 5 438/258 (2 OR, 3 XR) Class 438: SEMICONDUCTOR DEVICE MANUFACTURING: PROCESS MAKING FIELD EFFECT DEVICE HAVING PAIR OF 438/142 ACTIVE REGIONS SEPARATED BY GATE STRUCTURE BY FORMATION OR ALTERATION OF SEMICONDUCTIVE ACTIVE REGIONS .Having insulated gate (e.g., IGFET, MISFET, 438/197 MOSFET, etc.) .. Having additional gate electrode surrounded 438/257 by dielectric (i.e., floating gate) 438/258 ...Including additional field effect transistor (e.g., sense or access transistor, etc.) (3 OR, 1 XR) 4 257/319 Class 257: ACTIVE SOLID-STATE DEVICES FIELD EFFECT DEVICE 257/213 .Having insulated electrode (e.g., MOSFET, MOS 257/288 diode) .. Variable threshold (e.g., floating gate 257/314 memory device)